

## **68V N-Channel Trench MOSFET**

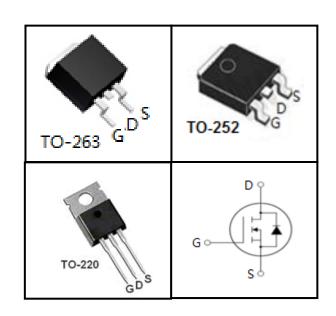
#### **FEATURES**

- Trench Power DTMOS technology
- Low RDS(ON)
- Low Gate Charge
- Optimized for fast-switching applications

#### **APPLICATIONS**

- Synchronous Rectification in DC/DC and AC/DC Converters
- Isolated DC/DC Converters in Telecom and Industrial

| Device Marking and Package Information |         |           |  |
|--|---------|-----------|--|
| Device                                 | Package | Marking   |  |
| CTD06N7P5                              | TO-252  | CTD06N7P5 |  |
| CTB06N7P5                              | TO-263  | CTB06N7P5 |  |
| CTP06N7P5                              | TO-220  | CTP06N7P5 |  |





| <b>Absolute Maximum Ratings</b> at T <sub>j</sub> = 25°C unless otherwise noted |                                   |          |      |  |
|---|-----------------------------------|----------|------|--|
| Parameter   | Symbol                            | Value    | Unit |  |
| Drain-Source Voltage (V <sub>GS</sub> = 0V)                                     | V <sub>DSS</sub>                  | 68       | V    |  |
| Continuous Drain Current  | I <sub>D</sub>                    | 95       | Α    |  |
| Pulsed Drain Current (note1)  | I <sub>DM</sub>                   | 380      | Α    |  |
| Gate Source Voltage   | V <sub>GSS</sub>                  | ±20      | V    |  |
| Single Pulse Avalanche Energy (note2)   | E <sub>AS</sub>                   | 380      | mJ   |  |
| Avalanche Current (note1)   | I <sub>AS</sub>                   | 37       | Α    |  |
| Power Dissipation T <sub>C</sub> = 25°C   | P <sub>D</sub>                    | 130.5    | W    |  |
| Operating Junction and Storage Temperature Range                                | T <sub>J</sub> , T <sub>stg</sub> | -55~+175 | °C   |  |

| Thermal Characteristics                 |                 |       |        |  |
|---|-----------------|-------|--------|--|
| Parameter                               | Symbol          | Value | Unit   |  |
| Thermal Resistance, Junction-Case       | $R_{\theta JC}$ | 1.15  | °C/W   |  |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 65    | 0, , , |  |



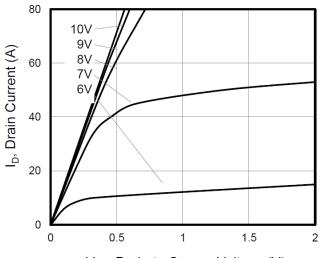
| Electrical Characteristics T <sub>j</sub> = 25°C unless otherwise specified |                     |  |       |      |      |       |
|---|---------------------|--|-------|------|------|-------|
| Parameter   |                     |  | Value |      |      | 11.24 |
| Parameter   | Symbol              | Test Conditions                                      | Min.  | Тур. | Max. | Unit  |
| Static  |                     |  |       |      |      |       |
| Drain-Source Breakdown Voltage  | $V_{(BR)DSS}$       | $V_{GS} = 0V, I_D = 250\mu A$                        | 68    |      |      | V     |
| Zero Gate Voltage Drain Current   | laaa                | $V_{DS} = 68V, V_{GS} = 0V, T_{J} = 25^{\circ}C$     |       |      | 1    | uA    |
| Zero Gate Voltage Brain Gurrent   | I <sub>DSS</sub>    | $V_{DS} = 68V, V_{GS} = 0V, T_{J} = 150^{\circ}C$    |       |      | 25   | uA    |
| Gate-Source Leakage   | $I_{GSS}$           | $V_{GS} = \pm 20V$                                   | 1     |      | ±100 | nA    |
| Gate-Source Threshold Voltage   | $V_{GS(th)}$        | $V_{DS} = V_{GS}$ , $I_D = 250\mu A$                 | 2     | 3    | 4    | V     |
| Drain-Source On-Resistance (note3)  | R <sub>DS(on)</sub> | $V_{GS} = 10V, I_{D} = 30A$                          |       | 6.5  | 7.5  | mΩ    |
| Forward Transconductance (Note3)  | gfs                 | VDS = 5V, ID = 20A                                   | 20    |      |      | S     |
|   |                     | Dynamic  |       |      |      |       |
| Input Capacitance   | C <sub>iss</sub>    | $V_{GS} = 0V$ ,                                      |       | 4169 |      | pF    |
| Output Capacitance  | $C_{oss}$           | $V_{DS} = 30V$ ,                                     |       | 274  |      |       |
| Reverse Transfer Capacitance  | $C_{rss}$           | f = 1.0MHz   |       | 222  |      |       |
| Total Gate Charge (10V)   | $Q_g$               |  |       | 70   |      |       |
| Gate-Source Charge  | $Q_gs$              | $V_{DD} = 30V, I_{D} = 20A, V_{GS} = 10V$            |       | 20   |      | nC    |
| Gate-Drain Charge   | $Q_gd$              |  |       | 18   |      |       |
| Turn-on Delay Time  | $t_{d(on)}$         |  |       | 15   |      |       |
| Turn-on Rise Time   | t <sub>r</sub>      | $V_{DS} = 30V, I_{D} = 20A$                          | -     | 94   |      | ns    |
| Turn-off Delay Time   | $t_{d(off)}$        | $R_G = 2.5\Omega$                                    |       | 46   |      | 113   |
| Turn-off Fall Time  | t <sub>f</sub>      |  |       | 32   |      |       |
| Body Diode Characteristics  |                     |  |       |      |      |       |
| Continuous Body Diode Current   | Is                  | T <sub>C</sub> = 25°C                                |       |      | 95   | Α     |
| Pulsed Diode Forward Current  | I <sub>SM</sub>     |  |       |      | 380  | Λ.    |
| Body Diode Voltage  | $V_{SD}$            | $T_J = 25^{\circ}C$ , $I_{SD} = 20A$ , $V_{GS} = 0V$ |       |      | 1.2  | V     |
| Reverse Recovery Time   | t <sub>rr</sub>     | $I_F = 20A$<br>$di_F/dt = 100A/\mu s$                |       | 78   |      | ns    |
| Reverse Recovery Charge   | $Q_{rr}$            |  | 1     | 51   |      | nC    |

#### Notes

- 1. 1.Repetitive Rating: Pulse Width limited by maximum junction temperature
- 2. 2.IAS = 37A, VDD = 50V, RG =  $25\Omega$ , Starting TJ =  $25^{\circ}$  C
- 3. 3.Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 1%

### **Typical Characteristics** $T_J = 25^{\circ}$ C, unless otherwise noted

Figure 1. Output Characteristics



 $V_{\text{DS}}$ , Drain-to-Source Voltage (V)

Figure 3. On-Resistance vs. Drain Current

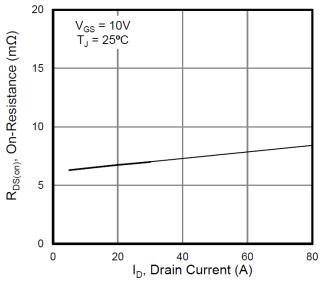


Figure 5. Gate Charge

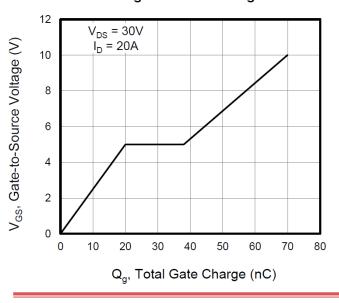


Figure 2. Transfer Characteristics

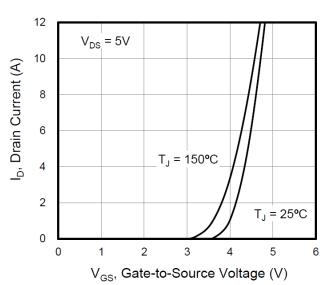


Figure 4. Capacitance

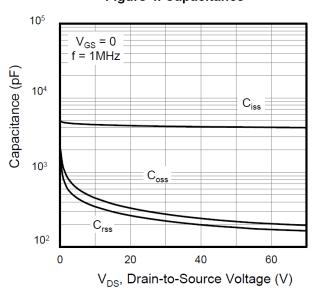
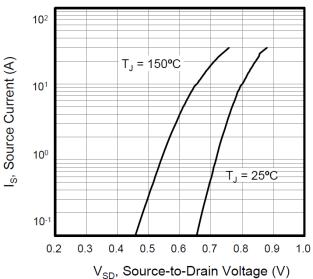


Figure 6. Body Diode Forward Voltage



### **Typical Characteristics** $T_J = 25^{\circ}\text{C}$ , unless otherwise noted

Figure 7. On-Resistance vs. Temperature

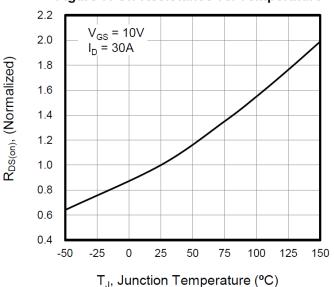


Figure 9. Transient Thermal Impedance

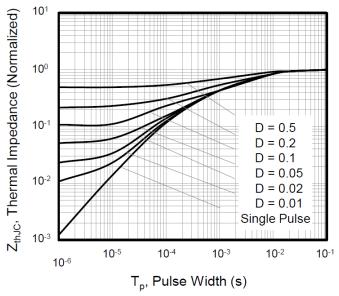
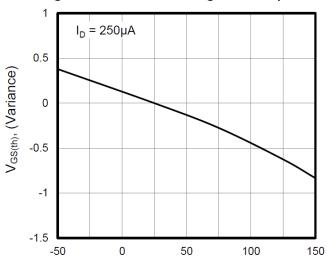
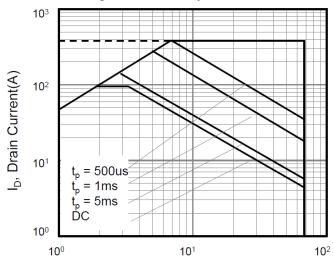


Figure 8. Threshold Voltage vs. Temperature



T<sub>J</sub>, Junction Temperature (°C)

Figure 10. Safe operation area



V<sub>DS</sub>, Drain-Source Voltage(V)

Figure A: Gate Charge Test Circuit and Waveform

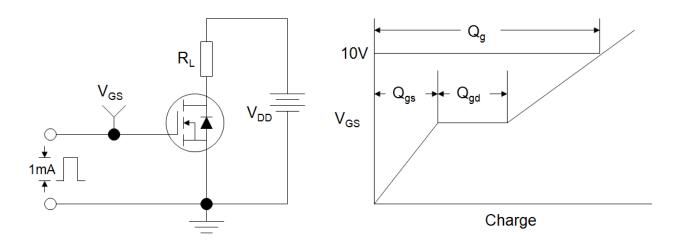


Figure B: Resistive Switching Test Circuit and Waveform

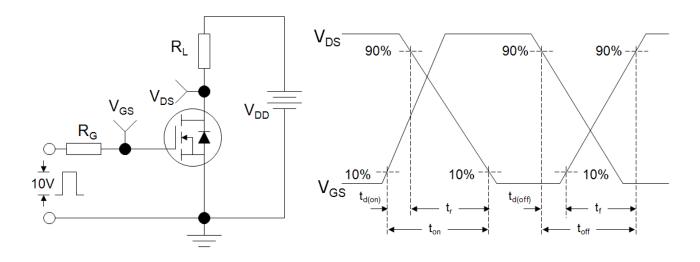
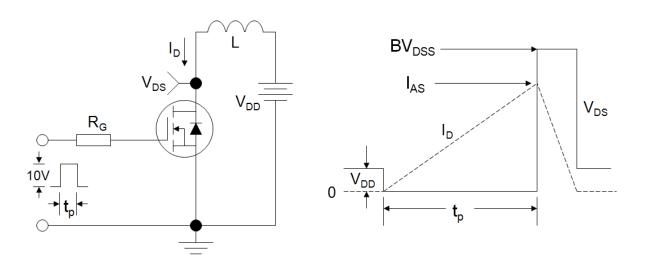
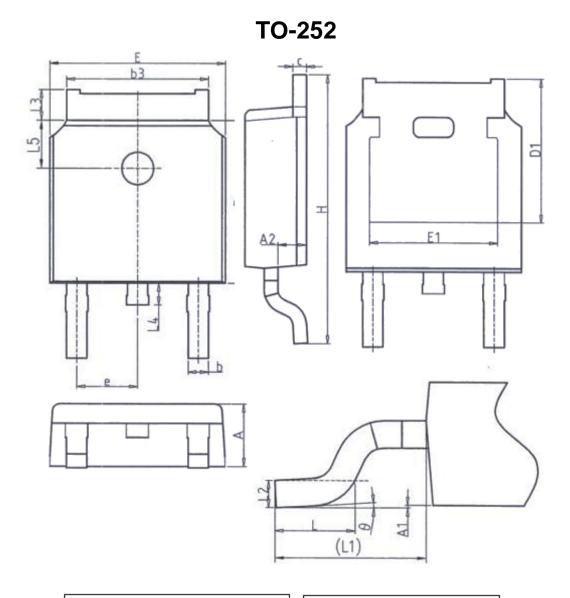


Figure C: Unclamped Inductive Switching Test Circuit and Waveform





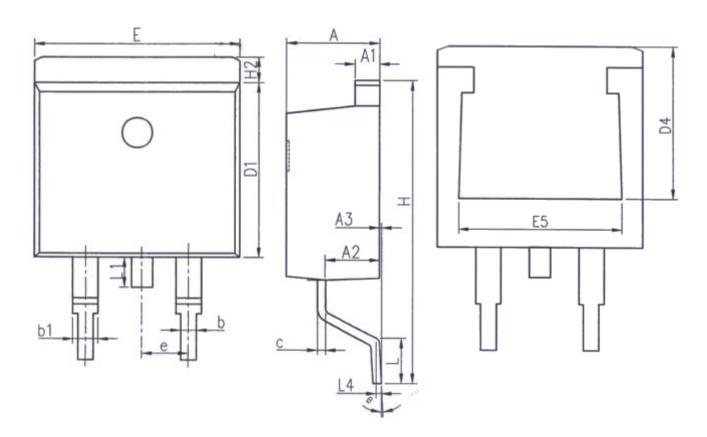


| Unit: mm |          |       |  |  |
|----------|----------|-------|--|--|
| Symbol   | Min.     | Max.  |  |  |
| Α        | 2. 20    | 2. 40 |  |  |
| A1       | 0.00     | 0. 20 |  |  |
| A2       | 0. 97    | 1. 17 |  |  |
| b        | 0. 68    | 0. 90 |  |  |
| b3       | 5. 20    | 5. 50 |  |  |
| С        | 0. 43    | 0. 63 |  |  |
| D        | 5. 98    | 6. 22 |  |  |
| D1       | 5. 30REF |       |  |  |
| E        | 6. 40    | 6. 80 |  |  |
| E1       | 4. 63    | _     |  |  |

| Unit: mm |          |       |  |
|----------|----------|-------|--|
| Symbol   | Min.     | Max.  |  |
| е        | 2. 28    | 6BSC  |  |
| Н        | 9. 40    | 10.50 |  |
| L        | 1. 38    | 1. 75 |  |
| L1       | 2. 90REF |       |  |
| L2       | 0. 51BSC |       |  |
| L3       | 0.88     | 1. 28 |  |
| L4       | -        | 1.00  |  |
| L5       | 1. 65    | 1. 95 |  |
| θ        | 0°       | 8°    |  |



# **TO-263**

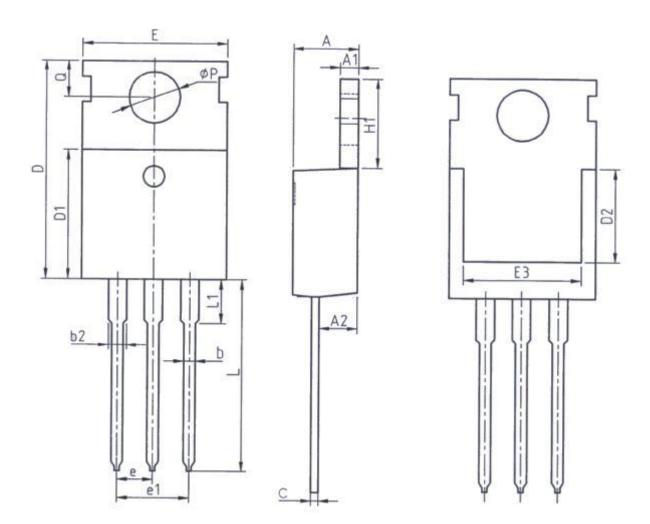


| Unit: mm   |       |       |  |
|------------|-------|-------|--|
| Symbol     | Min.  | Max.  |  |
| Α          | 4. 37 | 4. 77 |  |
| <b>A</b> 1 | 1. 22 | 1. 42 |  |
| A2         | 2. 49 | 2. 89 |  |
| A3         | 0.00  | 0. 25 |  |
| b          | 0. 70 | 0. 96 |  |
| b1         | 1. 17 | 1. 47 |  |
| С          | 0. 30 | 0. 53 |  |
| D1         | 8. 50 | 8. 90 |  |
| D4         | 6. 60 | _     |  |

| Unit: mm |          |        |  |
|----------|----------|--------|--|
| Symbol   | Min.     | Max.   |  |
| E        | 9.86     | 10.36  |  |
| E5       | 7. 06    | •      |  |
| е        | 2. 54BSC |        |  |
| Н        | 14. 70   | 15. 50 |  |
| H2       | 1. 07    | 1. 47  |  |
| L        | 2.00     | 2. 60  |  |
| L1       | 1. 40    | 1. 70  |  |
| L4       | 0. 25BSC |        |  |
| θ        | 0°       | 9°     |  |



# **TO-220**



| Unit: mm |        |        |  |  |
|----------|--------|--------|--|--|
| Symbol   | Min.   | Max.   |  |  |
| Α        | 4. 37  | 4. 77  |  |  |
| A1       | 1. 25  | 1. 45  |  |  |
| A2       | 2. 20  | 2. 60  |  |  |
| b        | 0. 70  | 0. 95  |  |  |
| b2       | 1. 17  | 1. 47  |  |  |
| С        | 0.40   | 0. 65  |  |  |
| D        | 15. 10 | 16. 10 |  |  |
| D1       | 8. 80  | 9. 40  |  |  |
| D2       | 5. 50  | _      |  |  |

| Unit: mm |          |        |  |
|----------|----------|--------|--|
| Symbol   | Min.     | Max.   |  |
| E        | 9. 70    | 10. 30 |  |
| E3       | 7. 00    | ı      |  |
| е        | 2. 54BSC |        |  |
| e1       | 5. 08BSC |        |  |
| H1       | 6. 25    | 6. 85  |  |
| L        | 12. 75   | 13.80  |  |
| L1       | _        | 3. 40  |  |
| P        | 3. 40    | 3. 80  |  |
| Q        | 2. 60    | 3. 00  |  |



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